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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/605,968	11/10/2003	Chin-Lung Lin	NAUP0543USA	2967
27765	7590 03/10/2006		EXAMINER	
NORTH AMERICA INTELLECTUAL PROPERTY CORPORATION			CHACKO DAVIS, DABORAH	
P.O. BOX 50 MERRIFIEL	D, VA 22116		ART UNIT	PAPER NUMBER
			1756	

DATE MAILED: 03/10/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
	10/605,968	LIN ET AL.	
Office Action Summary	Examiner	Art Unit	
	Daborah Chacko-Davis	1756	
The MAILING DATE of this communication ap Period for Reply	ppears on the cover sheet with	the correspondence addr	'ess
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING Decided of the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. If NO period for reply is specified above, the maximum statutory period Failure to reply within the set or extended period for reply will, by statut Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICAL. 136(a). In no event, however, may a replay will expire SIX (6) MONTH te, cause the application to become ABAN	ATION. ly be timely filed IS from the mailing date of this common that is seen to be seen that the seen that is seen to be seen that is seen that	
Status			
1)	is action is non-final. ance except for formal matter	•	nerits is
Disposition of Claims			
 4) ☐ Claim(s) 1-20 is/are pending in the application 4a) Of the above claim(s) is/are withdra 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-20 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/end. 	awn from consideration.		
Application Papers	·		
9) The specification is objected to by the Examination The drawing(s) filed on is/are: a) accomposed and applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examination is objected to by the Examination is objected.	cepted or b) objected to by drawing(s) be held in abeyance ction is required if the drawing(s)	e. See 37 CFR 1.85(a). is objected to. See 37 CFR	•
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureat * See the attached detailed Office action for a list	its have been received. Its have been received in Apporting documents have been received in Apporting the secondary (PCT Rule 17.2(a)).	olication No eceived in this National St	age
Attachment(s) 1) Notice of References Cited (PTO-892)	4) 🔲 Interview Sun	nmary (PTO-413)	
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	Paper No(s)/N	Mail Date rmal Patent Application (PTO-1	52)

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 2. Claims 1-2, 4, 7-20, are rejected under 35 U.S.C. 102(b) as being anticipated by U.S. Patent No. 6,388,736 (Smith et al., hereinafter referred to as Smith).

Smith, in col 3, lines 54-67, in col 4, lines 1-20, and lines 53-67, in col 6, lines 35-67, in col 7, lines 1-24, in col 8, lines 5-27, in col 9, lines 42-56, in col 10, lines 38-41, in col 12, lines 19-26, discloses an imaging method (lithographic process) of forming a resist pattern (relief pattern) on a substrate using a phase shifting mask, wherein the mask includes a plurality of first and second phase shifting transparent regions surrounding a feature in a continuous manner (spacing between patterns are small), opaque regions (0% transmission regions, adjacent and/or not adjacent the feature patterns, random features of 0% and 100% transmission of varying thicknesses), and the phase shift transparent regions are placed close to each other allowing phase shifting of 0° and 180° relative to each other (phase shift regions and the pattern feature), illuminating the mask to form the corresponding patterns on the substrate (claims 1, 8-9, 10-12, 13, 17-20). Smith, in col 10, lines 66-67, in col 11, lines 1-5, discloses a silicon dioxide substrate (claims 2, and 14). Smith, in col 1, lines 13-28, discloses that the pattern formed is a circuit pattern (claims 4, and 15). Smith, in col 6,

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lines 41-45, discloses that the phase shifting mask is a chromeless phase shifting mask (claims 7, and 16).

Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 3, 5-6, are rejected under 35 U.S.C. 103(a) as being unpatentable over U.
- S. Patent No. 6,388,736 (Smith et al., hereinafter referred to as Smith) in view of U. S. Patent Application Publication No. 2004/0013948 (Lin et al., herein after referred to as Lin).

Smith in col, 1, lines 13-24, and in col 3, lines 65-67, discloses an imaging method of forming circuit patterns (includes metal lines patterns) on a photosensitive material coated substrate (claim 6).

The difference between the claims and Smith is that Smith does not disclose that the photosensitive layer is a positive photoresist layer (claim 3). Smith does not disclose that the photosensitive layer is a negative photoresist layer (claim 5).

Lin, in [0002], and [0024], discloses a photolithographical method of performing exposure on a positive or a negative photoresist (photosensitive material) coated wafer so as to transfer equal or complementary patterns of the mask to the photosensitive material (claims 3, and 5).

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Therefore, it would be obvious to a skilled artisan to modify Smith by employing a positive or a negative photoresist material as the photosensitive material as suggested by Lin because Smith, in col 10, lines 66-67, in col 11, lines 1-5, discloses that the illumination process can be performed on a photosensitive material or resist material via a mask pattern, wherein the resist material enables pattern delineation and creation of masking apertures.

Conclusion

5. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Daborah Chacko-Davis whose telephone number is (571) 272-1380. The examiner can normally be reached on M-F 9:30 - 6:00. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Mark F Huff can be reached on (571) 272-1385. The fax phone number for the organization where this application or proceeding is assigned is (571) 273-8300. Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

dcd

March 3, 2006.

JOHNA. MCPHERSON PRIMARY EXAMINER